1 PTO-1595 (Rev. 09/ 04)	U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office
No. 0551-0027 (exp. 6/30/2005) RECORDATION FOR	M COVER SHEET
o the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.	
ORIMASA FURUKAWA	
URIMASA FOROIGTINT	
	Name: SONY CORPORATION
	Internal Address:
	Street Address:
Execution Date(s): February 17, 2006	7-35, Kitashinagawa 6-chome
	Shinagawa-Ku
). Nature of Conveyance:	
X Assignment Merger	Tokyo
Security Agreement Change of Name	City
Government Interest Assignment	State: JAPAN Zip: 141-0001
Executive Order 9424, Confirmatory License	
	Additional name(s) & address(es) Yes X No
Additional numbers attached	
Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and 1
Name: Robert B. Cohen LERNER, DAVID, LITTENBERG,	
KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Alty, Dkt.:	Authorized to be charged by credit card
-	
Street Address: 600 South Avenue West	X Authorized to be charged to deposit account
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	None required (government interest not affecting
City:Westfield	8. Payment Information a. Credit Card Last 4 Numbers
State:	Expiration Date
Phone Number: (908) 518-8310 Fax Number: (908) 654-0415	b. Deposit Account Number 12-1095
Email Address: rcohen@ldlkm.com	Authorized User Name Robert B. Cohen
9, Signature:	
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, Robert B. Cohen - 32,768	Total number of pages including cover 2 eheet, attachments, and documents:
Name of Person Signing	

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→ USPTO ASSIGNMENT 2003/003

S05P1637US00

SONYJP 3.0-515

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

ILLUMINATION APPARATUS AND IMAGE DISPLAY APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignce of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/314,769

This assignment executed on the dates indicated below.

Norimasa FURUKAWA

Name of first or sole inventor

Tokyo, Japan

Residence of first or sole inventor Norimasa Furukawa Feb. 17 2006

ate of this assignment

Execution date of U.S. Patent Application

Signature of first or sole inventor

RECORDED: 04/03/2006